

# Rail-to-Rail High Output Current Operational Amplifier

**OP279** 

#### **FEATURES**

Rail-to-Rail Inputs and Outputs High Output Current: ±80 mA Single Supply: +5 V to +12 V Wide Bandwidth: 5 M Hz High Slew Rate: 3 V/µs Low Distortion: 0.01% Unity-Gain Stable No Phase Reversal Short Circuit Protected

Drives Capacitive Loads: 10 nF

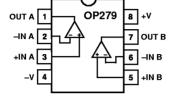
APPLICATIONS
Multimedia
Telecom
DAA Transformer Driver
LCD Driver
Low Voltage Servo Control

#### **FUNCTIONAL BLOCK DIAGRAM**

8-Lead Narrow Body SO (SO-8) 8- Lead Plastic DIP (N-8)



8- Lead TSSO P (RU Suffix)



PIN ROTATION IS THE SAME



#### **GENERAL DESCRIPTION**

The OP279 is a dual rail-to-rail, high output current, single-supply amplifier. It is designed for low voltage applications that require either current or capacitive load drive capability. The OP279 can sink and source currents of  $\pm 80$  m A (typ) and is stable with capacitive loads to 10 nF.

Applications that benefit from the OP279's high output current include driving headphones, displays, transform ers, and power transistors. The powerful output is combined with a unique input stage that maintains very low distortion with wide commonmode range, even in single supply designs.

The OP279 can be used as a buffer to provide m uch greater drive capability than can usually be provided by CM OS outputs. CM OS ASICs and DACs often have outputs that can swing to both the positive supply and ground, but are incapable of driving greater than a few milliam ps.

B andw idth is typically 5 M H z and the slew rate is 3 V  $\mu s$ , m aking these am plifiers well suited for single supply applications that require audio bandw idths when used in high gain configurations. O peration is guaranteed from voltages as low as 4.5 V , up to 12 V .

When using the OP279 in +5 volt systems, very good audio performance can be attained. THD is below 0.01% with a 600  $\Omega$  load, and noise is a respectable 21 nV  $\sqrt{\text{Hz}}$ . Supply current is less than 3.5 mA per amplifier.

The OP279 is available in 8-lead plastic DIP, TSSOP, and SO-8 surface mount packages. They are specified over the industrial  $(-40^{\circ}\text{C} \text{ to} + 85^{\circ}\text{C})$  temperature range.

# OP279-SPECIFICATIONS

# **ELECTRICAL SPECIFICATIONS** (@ $V_S$ = +5.0 V, $V_{CM}$ = 2.5 V, -40°C $\leq$ T<sub>A</sub> $\leq$ +85°C unless otherwise noted)

Parameter	Sym bol	Conditions	Min	Тур	M ax	Units	
IN PUT CHARACTER ISTICS Offset Voltage Input Bias Current Input Bias Current Input Offset Current Input Offset Current Input Offset Current Input Voltage Range Common-Mode Rejection Ratio Common-Mode Rejection Ratio Large Signal Voltage Gain Offset Voltage Drift	$V_{OS}$ $I_{B}$ $I_{B}$ $I_{OS}$ $I_{OS}$ $V_{CM}$ $CMRR$ $CMRR$ $A_{VO}$ $\Delta V_{OS}/\!\Delta T$	$\begin{split} & V_{\text{OUT}} = 2.5  \text{V} \\ & V_{\text{OUT}} = 2.5  \text{V}, T_{\text{A}} = +25^{\circ}\text{C} \\ & V_{\text{OUT}} = 2.5  \text{V} \\ & V_{\text{OUT}} = 2.5  \text{V}, T_{\text{A}} = +25^{\circ}\text{C} \\ & V_{\text{OUT}} = 2.5  \text{V} \end{split}$ $& V_{\text{CM}} = 0  \text{V to 5 V} \\ & V_{\text{CM}} = 0  \text{V to 3.5 V} \\ & R_{\text{L}} = 1  \text{k}\Omega, 0.3  \text{V} \leq V_{\text{OUT}} \leq 4.7  \text{V} \end{split}$	0 56 70 20	66	4 ±300 ±600 ±50 ±100	m V nA nA nA nA dB dB V /m V µV /°C	
OUTPUT CHARACTERISTICS OutputVoltage High OutputVoltage Low OutputVoltage Low ShortCircuitLimit Output Impedance	Voh Vol Vol Isc Zout	$\begin{split} & \mathbf{I_L} = 10 \text{ m A Source} \\ & \mathbf{I_L} = 10 \text{ m A Sink}, \mathbf{T_A} = +25^{\circ}\text{C} \\ & \mathbf{I_L} = 10 \text{ m A Sink} \\ & \mathbf{T_A} = +25^{\circ}\text{C} \\ & \mathbf{f} = 1 \text{ M H z, A}_{\text{V}} = 1 \end{split}$	+4.8 ±45	±80 22	75 100	V m V m V m A	
POWER SUPPLY Power Supply Rejection Ratio Supply Current/Amplifier Supply Voltage Range	PSRR I <sub>sy</sub> V <sub>s</sub>	$V_{s} = +4.5 \text{ V to} +12 \text{ V}$ $V_{our} = 2.5 \text{ V}$	76 +4.5	88 2.6	3.5 +12	dB m A V	
DYNAM IC PERFORM ANCE Slew Rate Gain Bandwidth Product Phase Margin Capacitive Load Drive	SR GBP <b>¢</b> m	$R_{L}=1$ k $\Omega$ , 1 nF N o 0 scillation		3 5 60 10		V /us M H z D egrees nF	
AUD 10 PERFORM ANCE Total Ham onic Distortion Voltage Noise Density	THD e <sub>n</sub>	f= 1 kH z		0.01 22		% nV <b>√Hz</b>	

# **ELECTRICAL SPECIFICATIONS** (@ $V_S = \pm 5.0 \text{ V}, -40^{\circ}\text{C} \le T_A \le +85^{\circ}\text{C}$ unless otherwise noted)

Parameter	Sym bol	Conditions	Min	Тур	Max	Units	
IN PUT CHARACTER ISTICS Offset Voltage Input Bias Current Input Bias Current Input Offset Current Input Offset Current Input Offset Current Input Voltage Range Common-Mode Rejection Ratio Large Signal Voltage Gain	Vos IB IB IOS IOS VCM CM RR AVO	$T_{A} = +25^{\circ}C$ $T_{A} = +25^{\circ}C$ $V_{CM} = -5 \text{ V to} + 5 \text{ V}$ $R_{L} = 1 \text{ k}\Omega, -4.7 \text{ V} \leq V_{OUT} \leq 4.7 \text{ V},$ $T_{A} = +25^{\circ}C$ $R_{L} = 1 \text{ k}\Omega, -4.7 \text{ V} \leq V_{OUT} \leq 4.7 \text{ V}$	-5 60 20 20	66	4 ±300 ±600 ±50 ±100 +5	m V nA nA nA nA v dB	
Offset Voltage Drift	$\Delta V_{OS} \Delta T$	N <sub>L</sub> - 1 N32, -4.7 V 3 V <sub>OUT</sub> 34.7 V	20	3		μV /°C	
OUTPUT CHARACTERISTICS OutputVoltageHigh OutputVoltageLow ShortCircuitLinit Open-LoopOutputInpedance	V <sub>OH</sub> V <sub>OL</sub> I <sub>SC</sub> Z <sub>OUT</sub>	$I_L = 10 \text{ m A Source}$ $I_L = 10 \text{ m A Sink}$ $T_A = +25^{\circ}\text{C}$ $f = 1 \text{ M H z, } A_V = +1$	+4.8 ±50	±80 22	-4.85	V V m A	
POWER SUPPLY Supply Cument/Amplifier	$I_{\mathtt{s}_{\mathtt{Y}}}$	$V_S = \pm 6 V$ , $V_{OUT} = 0 V$		2	3.75	m A	
DYNAM IC PERFORM ANCE Slew Rate Full-PowerBandwidth Gain Bandwidth Product PhaseMargin	SR BW p GBP <b>o</b> pra	$R_{\rm L}=1~{\rm k}\Omega$ , 1 nF 1% D istortion		3 5 69		Vuµs kHz MHz Degrees	
N O ISE PERFORM ANCE Voltage N oise Voltage N oise D ensity Current N oise D ensity	e <sub>n</sub> p−p e <sub>n</sub> in	0.1 H z to 10 H z f= 1 kH z		2 22 1		μV p-p nV MHz pA MHz	

Specifications subject to change without notice.

#### **ABSOLUTE MAXIMUM RATINGS**

Supply Voltage+16	V
Input Voltage+16	ν
Differential Input Voltage <sup>1</sup> ±1	. V
Output Short-Circuit Duration to GND Indefin	ite
Storage Tem perature Range	
P,S,RU Package65°C to +150	°C
O perating Tem perature Range	
OP279G40°C to +85	°C
Junction Temperature Range	
P, S, RU Package65°C to +150	°C
Lead Temperature Range (Soldering, 60 sec)+300	°C

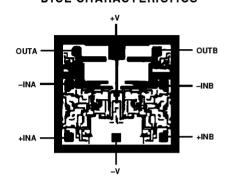
Package Type	$\theta_{JA}^2$	θ <sub>JC</sub>	Units		
8-Lead Plastic DIP (P)	103	43	°C M		
8-Lead SOIC (S)	158	43	°C /W		
8-Lead TSSOP (RU)	240	43	°C /W		

#### NOTES

#### **ORDERING GUIDE**

M odel	Temperature Range	Package Description	Package Option	
O P 279G P	-40°C to +85°C	8-Lead Plastic D IP	И –8	
OP279GS	-40°C to $+85$ °C	8-Lead SOIC	SO <del>-</del> 8	
O P 279G R U	-40°C to +85°C	8-Lead TSSOP	RU <del>-</del> 8	

#### **DICE CHARACTERISTICS**



OP279 Die Size  $0.070 \times 0.070$  inch, 4,900 sq. mils Substrate (Die Backside) Is Connected to V+. Transistor Count, 129

#### CAUTION\_

ESD (electrostatic discharge) sensitive device. E lectrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although the OP279 features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.



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 $<sup>^1\</sup>mathrm{T}$  he inputs are clamped with back-to-back diodes. If the differential input voltage exceeds 1 volt, the input current should be limited to 5 m A .

 $<sup>^2\</sup>theta_A$  is specified for the worst case conditions, i.e.,  $\theta_B$  is specified for device in socket for P-D IP, packages;  $\theta_B$  is specified for device soldered in circuit board for SO IC packages.

### **Typical Performance Graphs**

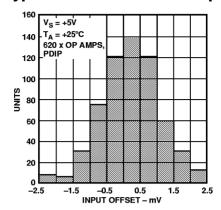


Figure 1. Input Offset Distribution

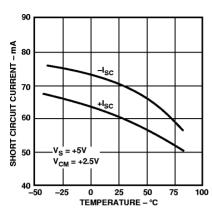


Figure 2. Short Circuit Current vs. Temperature

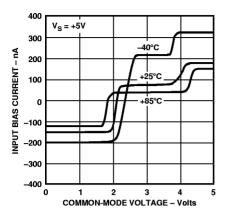


Figure 3. Input Bias Current vs. Common-Mode Voltage

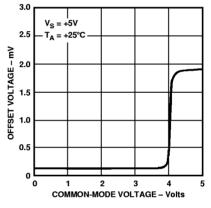


Figure 4. Offset Voltage vs. Common-Mode Voltage

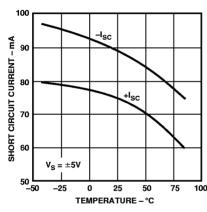


Figure 5. Short Circuit Current vs. Temperature

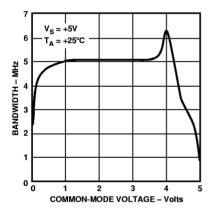


Figure 6. Bandwidth vs. Common-Mode Voltage

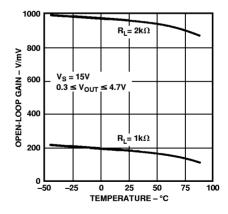


Figure 7. Open-Loop Gain vs. Temperature

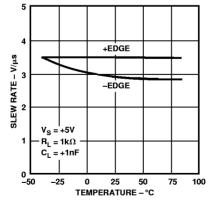


Figure 8. Slew Rate vs. Temperature

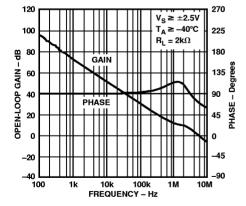


Figure 9. Open-Loop Gain and Phase vs. Frequency

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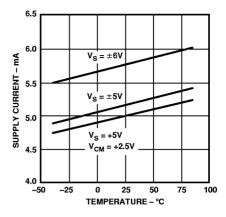


Figure 10. Supply Current vs. Temperature

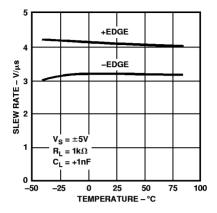


Figure 11. Slew Rate vs. Temperature

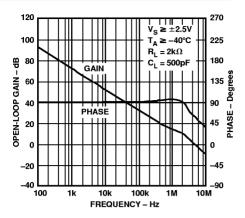


Figure 12. Open-Loop Gain and Phase vs. Frequency

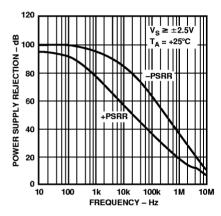


Figure 13. Power Supply Rejection vs. Frequency

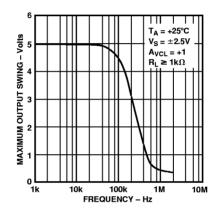


Figure 14. Maximum Output Swing vs. Frequency

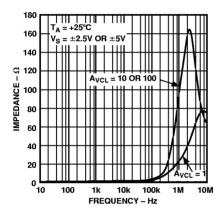


Figure 15. Closed-Loop Output Impedance vs. Frequency

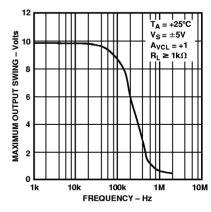


Figure 16. Maximum Output Swing vs. Frequency

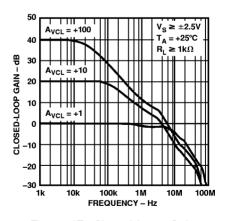


Figure 17. Closed-Loop Gain vs. Frequency

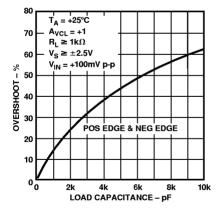


Figure 18. Small Signal Overshoot vs. Load Capacitance

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### **Typical Performance Graphs**

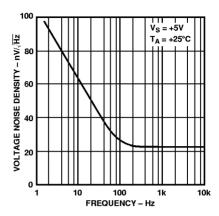


Figure 19. Voltage Noise Density vs. Frequency

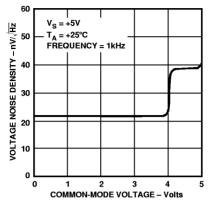


Figure 20. Voltage Noise Density vs. Common-Mode Voltage

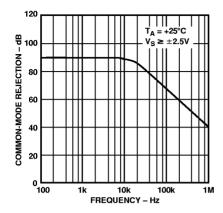


Figure 21. Common-Mode Rejection vs. Frequency

#### THEORY OF OPERATION

The OP279 is the latest entry in Analog D evices' expanding family of single-supply devices, designed for the multimedia and telecom marketplaces. It is a high output current drive, rail-to-rail input butput operational amplifier, powered from a single  $+5~\rm V$  supply. It is also intended for other low supply voltage applications where low distortion and high output current drive are needed. To combine the attributes of high output current and low distortion in rail-to-rail input/output operation, novel circuit design techniques are used.

For example, Figure 1 illustrates a simplified equivalent circuit for the OP279's input stage. It is comprised of two PNP differential pairs, Q 5-Q 6 and Q 7-Q 8, operating in parallel, with diode protection networks. Diode networks D5-D6 and D7-D8 serve to clam p the applied differential input voltage to the OP279, thereby protecting the input transistors against avalanche dam age. The fundam ental differences between these two PNP gain stages are that the Q7-Q8 pair are normally OFF and that their inputs are buffered from the operational amplifier inputs by 0.1-D.1-D.2 and 0.9-D.3-D.4. Operation is best understood as a function of the applied comm on-mode voltage: When the inputs of the OP279 are biased midway between the supplies, the differential signal path gain is controlled by the resistively loaded (via R7, R8) Q5-Q6. As the input com monm ode level is reduced toward the negative supply  $(V_{NEG})$  or GND), the input transistor current sources, Il and I3, are forced into saturation, thereby forcing the Q1-D1-D2 and Q 9-D 3-D 4 networks into cutoff; however, Q 5-Q 6 remain active, providing input stage gain. On the other hand, when the com m on-m ode input voltage is increased toward the positive supply, Q 5-Q 6 are driven into cutoff, Q 3 is driven into saturation, and Q 4 becomes active, providing bias to the Q 7-Q 8 differential pair. The point at which the Q7-Q8 differential pair becomes active is approximately equal to  $(V_{POS} - 1 V)$ .

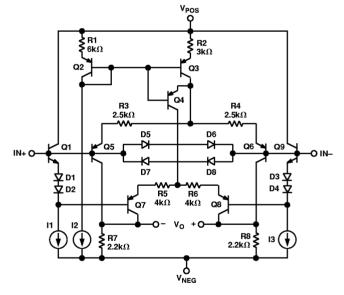


Figure 22. OP279 Equivalent Input Circuit

The key issue here is the behavior of the input bias currents in this stage. The input bias currents of the 0 P 279 over the range of common-mode voltages from  $(V_{\rm NEG}+1\,\rm V)$  to  $(V_{\rm POS}-1\,\rm V)$  are the arithmetic sum of the base currents in Q 1-Q 5 and Q 9-Q 6. O utside of this range, the input bias currents are dominated by the base current sum of Q 5-Q 6 for input signals close to  $V_{\rm NEG}$ , and of Q 1-Q 5 (Q 9-Q 6) for input signals close to  $V_{\rm POS}$ . As a result of this design approach, the input bias currents in the 0 P 279 not only exhibit different amplitudes, but also exhibit different polarities. This input bias current behavior is best illustrated in Figure 3. It is, therefore, of paramount importance that the effective source impedances connected to the 0 P 279's inputs are balanced for optim umdc and acperformance.

In order to achieve rail-to-rail output behavior, the OP279 design employs a complementary common-emitter (or  $g_n\,R_{\,\rm L}$ ) output stage (Q15-Q16), as illustrated in Figure 23. These amplifiers provide output current until they are forced into saturation which occurs at approximately 50 mV from either supply rail. Thus, their saturation voltage is the limit on the maximum output voltage swing in the OP279. The output stage also exhibits voltage gain, by virtue of the use of common-emitter amplifiers; and, as a result, the voltage gain of the output stage (thus, the open-loop gain of the device) exhibits a strong dependence to the total load resistance at the output of the OP279 as illustrated in Figure 7.

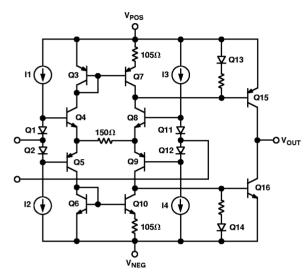


Figure 23. OP279 Equivalent Output Circuit

#### Input Overvoltage Protection

As with any sem iconductor device, whenever the condition exists for the input to exceed either supply voltage, the device's input overvoltage characteristic must be considered. When an overvoltage occurs, the amplifier could be damaged depending on the magnitude of the applied voltage and the magnitude of the fault current. Figure 24 illustrates the input overvoltage characteristic of the OP279. This graph was generated with the power supplies at ground and a curve tracer connected to the input. As can be seen, when the input voltage exceeds either supply by more than 0.6 V, internal pn-junctions energize which allow current to flow from the input to the supplies. As illustrated in the simplified equivalent input circuit (Figure 22), the OP279 does not have any internal current limiting resistors, so fault currents can quickly rise to damaging levels.

This input current is not inherently dam aging to the device as long as it is lim ited to 5 m A or less. For the 0 P279, once the input voltage exceeds the supply by m ore than 0.6 V, the input current quickly exceeds 5 m A . If this condition continues to exist, an external series resistor should be added. The size of the resistor is calculated by dividing the m axim um overvoltage by 5 m A . For exam ple, if the input voltage could reach 100 V, the external resistor should be (100 V/5 m A) = 20 k $\Omega$ . This resistance should be placed in series with either or both inputs if they are exposed to an overvoltage. A gain, in order to ensure optim um dc and ac performance, it is in portant to balance source in pedance levels. For more information on general

overvoltage characteristics of am plifiers refer to the **1993 Seminar Applications Guide**, available from the Analog D evices Literature C enter.

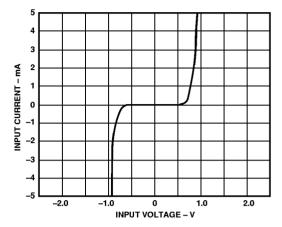


Figure 24. OP279 Input Overvoltage Characteristic

#### Output Phase Reversal

Som e operational am plifiers designed for single-supply operation exhibit an output voltage phase reversal when their inputs are driven beyond their useful com m on-m ode range. Typically for single-supply bipolar op am ps, the negative supply determines the lower limit of their com m on-m ode range. With these devices, external clamping diodes, with the anode connected to ground and the cathode to the inputs, prevent input signal excursions from exceeding the device's negative supply (i.e., GND), preventing a condition that could cause the output voltage to change phase. JFET-input amplifiers may also exhibit phase reversal, and, if so, a series input resistor is usually required to prevent it.

The 0P279 is free from reasonable input voltage range restrictions provided that the input voltages no greater than the supply voltages are applied. Although the device's output will not change phase, large currents can flow through the input protection diodes, previously shown in Figure 22. Therefore, the technique recommended in the "Input 0 vervoltage Protection" section should be applied in those applications where the likelihood of input voltages exceeding the supply voltages is possible.

#### Capacitive Load Drive

The OP279 has excellent capacitive load driving capabilities. It can drive up to 10 nF directly as the perform ance graph titled "Sm all Signal O vershoot vs. I, oad C apacitance" (Figure 18) shows. However, even though the device is stable, a capacitive load does not come without a penalty in bandwidth. As shown in Figure 25, the bandwidth is reduced to under 1 MHz for loads greater than 3 nF. A "snubber" network on the output won't increase the bandwidth, but it does significantly reduce the amount of overshoot for a given capacitive load. A snubber consists of a series R-C network (Rs, Cs), as shown in Figure 26, connected from the output of the device to ground. This network operates in parallel with the load capacitor, C $_{\rm L}$ , to provide phase lag compensation. The actual value of the resistor and capacitor is best determined empirically.

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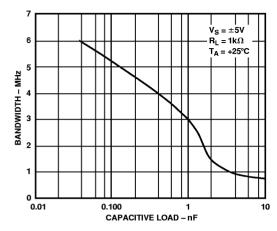


Figure 25. OP279 Bandwidth vs. Capacitive Load

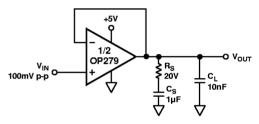


Figure 26. Snubber Network Compensates for Capacitive Load

The first step is to determ ine the value of the resistor,  $R_{\rm S}$ . A good starting value is  $100~\Omega$  (typically, the optim um value will be less than  $100~\Omega$ ). This value is reduced until the small-signal transient response is optimized. Next,  $C_{\rm S}$  is determined—  $10~\mu{\rm F}$  is a good starting point. This value is reduced to the smallest value for acceptable performance (typically,  $1~\mu{\rm F}$ ). For the case of a  $10~n{\rm F}$  load capacitor on the OP279, the optimal snubber network is a  $20~\Omega$  in series with  $1~\mu{\rm F}$ . The benefit is in mediately apparent as seen in the scope photo in Figure 27. The top trace was taken with a  $10~n{\rm F}$  load and the bottom trace with the  $20~\Omega$ ,  $1~\mu{\rm F}$  snubber network in place. The amount of overshot and ringing is dram atically reduced. Table I below illustrates a few sample snubber networks for large load capacitors.

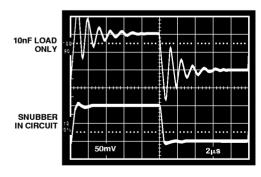


Figure 27. Overshoot and Ringing Is Reduced by Adding a "Snubber" Network in Parallel with the 10 nF Load

Table I. Snubber Networks for Large Capacitive Loads

Load Capacitance (C <sub>L</sub> )	Snubber Network (R <sub>S</sub> , C <sub>S</sub> )
10 nF	20 <b>Ω,</b> 1 μF
100 nF	5 <b>Ω,</b> 10 μF
1 μF	0 Ω, 10 μΕ

#### **Overload Recovery Time**

O verload, or overdrive, recovery time of an operational amplifier is the time required for the output voltage to recover to its linear region from a saturated condition. This recovery time is important in applications where the amplifier must recover after a large transient event. The circuit in Figure 28 was used to evaluate the OP279's overload recovery time. The OP279 takes approximately 1  $\mu s$  to recover from positive saturation and approximately 1.2  $\mu s$  to recover from negative saturation.

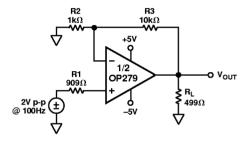


Figure 28. Overload Recovery Time Test Circuit

#### **Output Transient Current Recovery**

In m any applications, operational amplifiers are used to provide moderate levels of output current to drive the inputs of ADCs, smallmotors, transmission lines, and current sources. It is in these applications that operational amplifiers must recover quickly to step changes in the load current while maintaining steady-state load current levels. Because of its high output current capability and low closed-loop output in pedance, the OP279 is an excellent choice for these types of applications. For example, when sourcing or sinking a 25 mA steady-state load current, the OP279 exhibits a recovery time of less than 500 ns to 0.1% for a 10 mA (i.e., 25 mA to 35 mA and 35 mA to 25 mA) step change in load current.

#### A Precision Negative Voltage Reference

In m any data acquisition applications, the need for a precision negative reference is required. In general, any positive voltage reference can be converted into a negative voltage reference through the use of a operational amplifier and a pair of m atched resistors in an inverting configuration. The disadvantage to that approach is that the largest single source of error in the circuit is the relative m atching of the resistors used.

The circuit illustrated in Figure 29 avoids the need for tightly matched resistors with the use of an active integrator circuit. In this circuit, the output of the voltage reference provides the input drive for the integrator. The integrator, to maintain circuit equilibrium, adjusts its output to establish the proper relationship between the reference's  $V_{\text{OUT}}$  and GND. Thus, various negative output voltages can be chosen be simply substituting for the appropriate reference IC (see table). To speed up the

ON-OFF settling time of the circuit, R2 can be reduced to 50 k $\Omega$  or less. Although the integrator's time constant chosen here is 1 ms, room exists to trade off circuit bandwidth and noise by increasing R3 and decreasing C2. The SHUTDOWN feature is maintained in the circuit with the simple addition of a PNP transistor and a 10 k $\Omega$  resistor. One caveat with this approach should be mentioned: although rail-to-rail output amplifiers work best in the application, these operational amplifiers require a finite amount (mV) of headroom when required to provide any load current. The choice for the circuit's negative supply should take this issue into account.

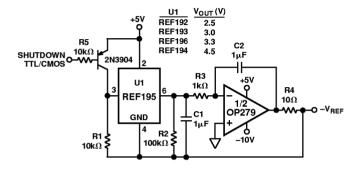


Figure 29. A Negative Precision Voltage Reference That Uses No Precision Resistors Exhibits High Output Current Drive

#### A High Output Current, Buffered Reference/Regulator

M any applications require stable voltage outputs relatively close in potential to an unregulated input source. This "low dropout" type of reference/regulator is readily in plemented with a rail-to-rail output op amp, and is particularly useful when using a higher current device such as the OP279. A typical example is the 3.3 V or 4.5 V reference voltage developed from a 5 V system source. Generating these voltages requires a three-term inal reference, such as the REF196 (3.3 V) or the REF194 (4.5 V), both of which feature low power, with sourcing outputs of 30 m A or less. Figure 30 shows how such a reference can be outfitted with a OP279 buffer for higher currents and/or voltage levels, plus sink and source load capability.

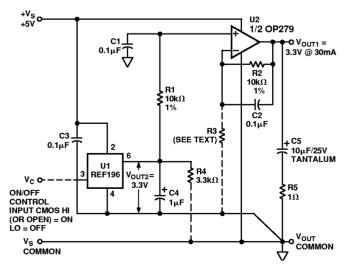


Figure 30. A High Output Current Reference/Regulator

The low dropout perform ance of this circuit is provided by stage U 2, one half of an O P 279 connected as a follower/buffer for the basic reference voltage produced by U 1. The low voltage saturation characteristic of the O P 279 allow sup to 30 m A of load current in the illustrated use, as a 5 V to 3.3 V converter with high dc accuracy. In fact, the dc output voltage change for a 30 m A load current delta m easures less than 1 m V . This corresponds to an equivalent output in pedance of < 0.03  $\Omega$ . In this application, the stable 3.3 V from U 1 is applied to U 2 through a noise filter, R1-C1.U2 replicates the U 1 voltage within a few m V, but at a higher current output at V\_OUT1, with the ability to both sink and source output current(s)— unlike m ost IC references. R2 and C2 in the feedback path of U2 provide bias compensation for lowest dc error and additional noise filtering.

T ransient perform ance of the reference/regulator for a 10 m A step change in load current is also quite good and is determ ined largely by the R 5-C 5 output network. W ith values as shown, the transient is about 10 m V peak and settles to within 2 m V in 8  $\mu s$ , for either polarity. A lthough room exists for optimizing the transient response, any changes to the R 5-C 5 network should be verified by experiment to preclude the possibility of excessive ringing with some capacitor types.

To scale  $V_{\text{OUT2}}$  to another (higher) output level, the optional resistor R3 (shown dotted) is added, causing the new  $V_{\text{OUT1}}$  to become:

$$V_{OUT1} = V_{OUT2} \times \left(1 + \frac{R2}{R3}\right)$$

As an example, for a  $V_{\text{OUT1}}=4.5\,\text{V}$ , and  $V_{\text{OUT2}}=2.5\,\text{V}$  from a REF192, the gain required of U 2 is  $1.8\,\text{tim}$  es, so R 2 and R 3 would be chosen for a ratio of 0.8:1, or  $18\,\text{k}\Omega$ :22.5 k $\Omega$ . Note that for the lowest  $V_{\text{OUT1}}$  dc error, the parallel combination of R 2 and R 3 should be maintained equal to R 1 (as here), and the R 2-R 3 resistors should be stable, close tolerance metal film types.

The circuit can be used either as shown as a 5 V to 3.3 V reference/regulator, or it can also be used with 0 N  $\not$ 0 FF control. By driving P in 3 of U 1 with a logic control signal as noted, the output is switched 0 N  $\not$ 0 FF. N ote that when 0 N  $\not$ 0 FF control is used, resistor R 4 should be used with U 1 to speed 0 N  $\not$ 0 FF switching.

#### Direct Access Arrangement for Telephone Line Interface

Figure 31 illustrates a + 5 V only transm it/receive telephone line interface for 110  $\Omega$  transm ission system s. It allows full duplex transm ission of signals on a transform er coupled 110  $\Omega$  line in a differentialm anner. Am plifier A1 provides gain that can be adjusted to meet the modem output drive requirements. Both A1 and A2 are configured so as to apply the largest possible signal on a single supply to the transform er. Because of the OP279's high output current drive and low dropout voltage, the largest signal available on a single + 5 V supply is approximately  $4.5~\mathrm{V}$  p-p into a  $110~\Omega$  transm ission system . Am plifier A 3 is configured as a difference amplifier to extract the receive signal from the transmission line for am plification by A4. A4's gain can be adjusted in the samem anner as A1's to meet the m odem 's input signal requirem ents. Standard resistor values perm it the use of SIP (Single In-line Package) form at resistor arrays. Couple this with the OP279's 8-pin SOIC footprint and this circuit offers a compact, cost-sensitive solution.

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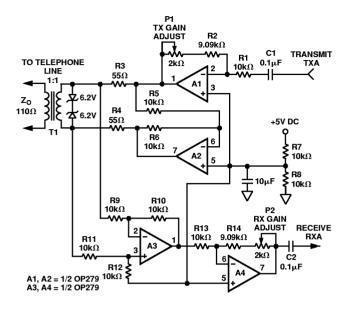


Figure 31. A Single-Supply Direct Access Arrangement for Modems

#### A Single-Supply, Remote Strain Gage Signal Conditioner

The circuit in Figure 32 illustrates a way by which the OP279 can be used in a +12 V single-supply, 350  $\Omega$  strain gage signal conditioning circuit. In this circuit, the OP279 serves two functions: (1) By servoing the output of the REF43's +2.5 V output across R1, it provides a 20 m A drive to the 350  $\Omega$  strain gauge. In this way, small changes in the strain gage produce large differential output voltages across the AM P04's inputs. (2) To maxim ize the circuit's dynam ic range, the other half of the OP279 is configured as a supply-splitter connected to the

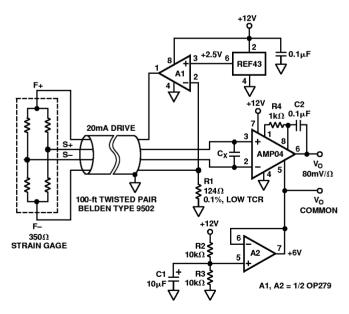


Figure 32. A Single-Supply, Remote Strain Gage Signal Conditioner

AM P04's REF term inal. Thus, tension or compression in the application can be measured by the circuit. The AM P04 is configured for a gain of 100, producing a circuit sensitivity of 80 m V  $\Omega$ . Capacitor C2 is used across the AM P04's Pins 8 and 6 to provide a 16-Hz noise filter. If additional noise filtering is required, an optional capacitor, C $_{\rm X}$ , can be used across the AM P04's input to provide differential-mode noise rejection.

#### A Single-Supply, Balanced Line Driver

The circuit in Figure 33 is a unique line driver circuit topology used in professional audio applications and has been modified for autom otive audio applications. On a single +12 V supply, the line driver exhibits less than 0.02% distortion into a 600  $\Omega$  load across the entire audio band (not shown). For bads greater than 600  $\Omega$ , distortion perform ance in proves to where the circuit exhibits less than 0.002%. The design is a transform erless, balanced transm ission system where output common-mode rejection of noise is of paramount in portance. Like the transform er-based system, either output can be shorted to ground for unbalanced line driver applications without changing the circuit gain of 1. O ther circuit gains can be set according to the equation in the diagram. This allows the design to be easily configured for noninverting, inverting, or differential operation.

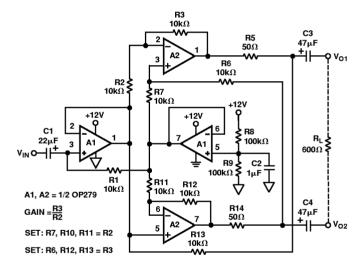


Figure 33. A Single-Supply, Balanced Line Driver for Automotive Applications

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#### A Single-Supply Headphone Amplifier

Because of its high speed and large output drive, the OP279 m akes for an excellent headphone driver, as illustrated in Figure 34. Its low supply operation and rail-to-rail inputs and outputs give a maximum signal swing on a single +5 V supply. To insure maximum signal swing available to drive the headphone, the amplifier inputs are biased to V+/2, which is in this case 2.5 V. The 100 k $\Omega$  resistor to the positive supply is equally split into two 50 k $\Omega$  with their common point bypassed by 10  $\mu F$  to prevent power supply noise from contaminating the audio signal.

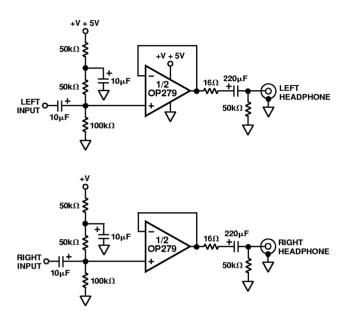


Figure 34. A Single-Supply, Stereo Headphone Driver

The audio signal is then ac-coupled to each input through a 10  $\mu F$  capacitor. A large value is needed to ensure that the 20 H z audio inform ation is not blocked. If the input already has the proper dc bias, then the ac coupling and biasing resistors are not required. A 220  $\mu F$  capacitor is used at the output to couple the amplifier to the headphone. This value is much larger than that used for the input because of the low in pedance of the headphones, which can range from 32  $\Omega$  to 600  $\Omega$ . An additional 16  $\Omega$  resistor is used in series with the output capacitor to protect the op amp's output stage by limiting capacitor discharge current. When driving a 48  $\Omega$  boad, the circuit exhibits less than 0.02% THD+N at low output drive levels (not shown). The 0 P279's high current output stage can drive this heavy load to 4 V p-p and maintain less than 1% THD+N .

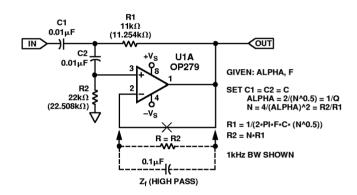
#### **Active Filters**

Several active filter topologies are useful with the OP279. Am ong these are two popular architectures, the familiar Sallen-Key (SK) voltage controlled voltage source (VCVS) and the multiple feedback (MFB) topologies. These filter types can be arranged for high pass (HP), low pass (LP), and bandpass (BP) filters. The SK filter type uses the op amp as a fixed gain voltage follower at unity or a higher gain, while the MFB structure uses it as an inverting stage. Discussed here are simplified, 2-pole forms of these filters, highly useful as system building blocks.

# UNITY-GAIN, SALLEN-KEY (VCVS) FILTERS High Pass Configurations

In Figure 35a is the HP form of a unity-gain 2-pole SK filter using an 0 P279 section. For this filter and its LP counterpart, the gain in the passband is inherently unity, and the signal phase is non inverting due to the follower hookup. For simplicity and practicality, capacitors C 1-C 2 are set equal, and resistors R2-R1 are adjusted to a ratio "N ," which provides the filter damping " $\alpha$ " as per the design expressions. A HP design is begun with selection of standard capacitor values for C1 and C2 and a calculation of N; then R1 and R2 are calculated as per the figure expressions.

In these examples,  $\alpha$  (or 1/Q) is set equal to  $\sqrt{2}$ , providing a Butterworth (maximally flat) response characteristic. The filter corner frequency is normalized to 1 kHz, with resistor values shown in both rounded and (exact) form. Various other 2-pole response shapes are also possible with appropriate selection of  $\alpha$ . For a given response type ( $\alpha$ ), frequency can be easily scaled, using proportional R or C values.



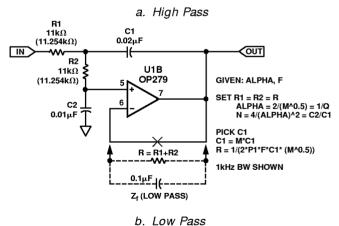


Figure 35. 2-Pole Unity-Gain Sallen Key HP/LP Filters

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#### Low Pass Configurations

In the LP SK arrangement of Figure 35b, R and C elements are interchanged, and the resistors are made equal. Here the C  $2\,\mathcal{L}\,1$  ratio "M" is used to set the filter  $\alpha$ , as noted. This design is begun with the choice of a standard capacitor value for C 1 and a calculation of M, which forces a value of "M  $\times$  C 1" for C 2. Then, the value "R" for R1 and R2 is calculated as per the expression .

For highest perform ance, the passive components used for tuning active filters deserve attention. Resistors should be 1%, low TC, metal film types of the RN 55 or RN 60 style, or similar. Capacitors should be 1% or 2% film types preferably, such as polypropylene or polystyrene, or NPO (COG) ceram ic for smaller values. Somewhat lesser perform ance is available with the use polyester capacitors.

#### Parasitic Effects in Sallen-Key Implementations

In designing these circuits, moderately low (10 k $\Omega$  or less) values for R1-R2 can be used to m in in ize the effects of Johnson noise when critical, with of course practical tradeoffs of capacitor size and expense. DC errors will result for larger values of resistance, unless bias current compensation is used. To add bias compensation in the HP filter of Figure 35a, a feedback compensation resistor with a value equal to R2 is used, shown optionally as Z f. This willminimize bias induced offset, reducing it to the product of the OP279's  $I_{OS}$  and R2. Sim ilar compensation is applied to the LP filter, using a Z<sub>f</sub> resistance of R1 + R2. Using dc compensation and relatively low filter values, filter output dc errors using the OP279 will be dominated by Vos, which is limited to 4 mV or less. A caveathere is that the additional resistors increase noise substantially-for exam p.le., an unbypassed 10 k $\Omega$  resistor generates  $\approx$  12 nV NHz of noise. However, the resistance can be ac-bypassed to elim inate noise with a simple shunt capacitor, such as  $0.1 \, \mu F$ .

#### Sallen-Key Implementations in Single-Supply Applications

The hookups shown illustrate a classical dual supply op am p application, which for the OP279 would use supplies up to  $\pm 5\,\mathrm{V}$ . However, these filters can also use the op amp in a single-supply mode, with little if any alteration to the filter itself. To operate single-supply, the OP279 is powered from  $+5\,\mathrm{V}$  at Pin 8 with Pin 4 grounded. The input do bias for the op amp must be supplied from a do source equal to 1/2 supply, or  $2.5\,\mathrm{V}$  in this case.

For the HP section, dc bias is applied to the comm on end of R2. R2 is simply returned to an ac ground that is a well-bypassed 2:1 divider across the 5 V source. This can be as simple as a pair of 100 k $\Omega$  resistors with a 10  $\mu\mathrm{F}$  bypass cap. The output from the stage is then ac coupled, using an appropriate coupling cap from U 1A to the next stage. For the LP section dc bias is applied to the input end of R1, in comm on with the input signal. This dc can be taken from an unbypassed dual 100 k $\Omega$  divider across the supply, with the input signal ac coupled to the divider and R1.

#### Multiple Feedback Filters

MFB filters, like their SK relatives, can be used as building blocks as well. They feature LP and HP operation as well, but can also be used in a bandpass BP mode. They have the property of inverting operation in the pass band, since they are based on an inverting am plifier structure. Another useful asset is their ability to be easily configured for gain.

#### **High Pass Configurations**

In Figure 36 is an HPM FB 2-pole filter using an OP279 section. For this filter, the gain in the passband is user configurable, and the signal phase is inverting. The circuit uses one more tuning component than the SK types. For simplicity, capacitors C1 and C3 are set to equal standard values, and resistors R1-R2 are selected as per the relationships noted. Gain of this filter, H, is set by capacitors C1 and C2, and this factor limits both gain selectability and precision. Also, input capacitance C1 makes the load seen by the driving stage highly reactive, and limits overall practicality of this filter. The dire effect of C1 loading can be tempered somewhat by using a small series input resistance of about 100  $\Omega$ , but can still be an issue.

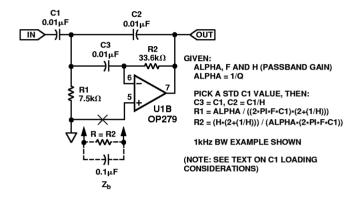


Figure 36. Two-Pole, High Pass Multiple Feedback Filters

In this example, the filter gain is set to unity, the corner frequency is 1 kH z, and the response is a Butterworth type. For applications where dc output offset is critical, bias current compensation can be used for the amplifier. This is provided by network  $\mathbf{Z}_{b}$ , where R is equal to R2, and the capacitor provides a noise bypass.

#### Low Pass Configurations

Figure 37 is a LP M FB 2-pole filter using an OP279 section . For this filter, the gain in the pass band is user configurable over a wide range, and the pass band signal phase is inverting. Given the design parameters for  $\alpha$ , F, and H, a sin plifted design process is begun by picking a standard value for C2. Then C1 and resistors R1-R3 are selected as per the relationships noted. Optional dc bias current compensation is provided by  $Z_{\rm b}$ , where R is equal to the value of R3 plus the parallel equivalent value of R1 and R2.

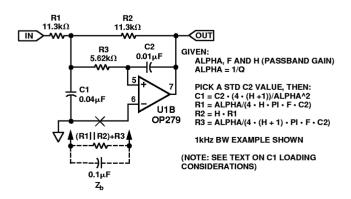


Figure 37. Two-Pole, Low Pass Multiple Feedback Filters

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G ain of this filter, H , is set here by resistors R 2 and R 1 (as in a standard op am p inverter), and can be just as precise as these resistors allow at low frequencies. Because of this flexible and accurate gain characteristic, plus a low range of component value spread, this filter is perhaps the most practical of all the MFB types. C apacitor ratios are best satisfied by paralleling two ormore common types, as in the example, which is a  $1~\rm kH~z$  unity gain Butterworth filter.

#### **Bandpass Configurations**

The MFB bandpass filter using an OP279 section is shown in Figure 38. This filter provides reasonably stable medium Q designs for frequencies of up to a few kHz. For best predictability and stability, operation should be restricted to applications where the OP279 has an open-loop gain in excess of  $2Q^2$  at the filter center frequency.

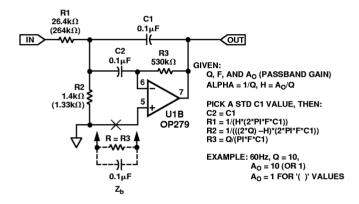


Figure 38. Two-Pole, Bandpass Multiple Feedback Filters

G iven the bandpass design param eters for Q, F, and pass band gain  $A_{\text{O}}$ , the design process is begun by picking a standard value for C1. Then C2 and resistors R1-R3 are selected as per the relationships noted. This filter is subject to a wide range of component values by nature. Practical designs should attempt to restrict resistances to a 1 k $\Omega$  to 1 M  $\Omega$  range, with capacitor values of 1  $\mu F$  or less. When needed, dcb as current compensation is provided by  $Z_{\text{b}}$ , where R is equal to R3.

#### 2-Way Loudspeaker Crossover Networks

A ctive filters are useful in loudspeaker crossover networks for reasons of small size, relative freedom from parasitic effects, and the ease of controlling low high channel drive, plus the controlled driver damping provided by a dedicated amplifier. Both Sallen-Key (SK) VCVS and multiple-feedback (MFB) filter architectures are useful in in plementing active crossover networks (see Reference 4), and the circuit shown in Figure 39 is a 2-way active crossover which combines the advantages of both filter topologies. This active crossover exhibits less than 0.01% THD+N at output levels of 1 V ms using general purpose unity

gain HP/LP stages. In this 2-way example, the LO signal is a dc-500 H z LP woofer output, and the H I signal is the HP (> 500 H z) tweeter output. U 1B form saM FB LP section at 500 H z, while U 1A provides a SK HP section, covering frequencies  $\geq$  500 H z.

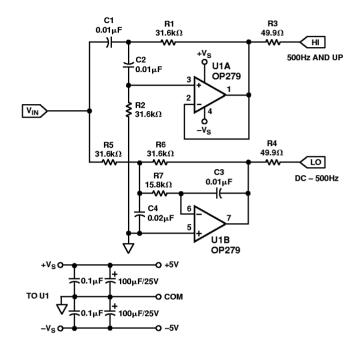


Figure 39. Two-Way Active Crossover Networks

This crossover network is a Linkw itz-Riley type (see Reference 5), with a damping factor or  $\alpha$  of 2 (also referred to as "Butterworth squared"). A hallmark of the Linkw itz-Riley type of filter is the fact that the summed magnitude response is flat across the pass band. A necessary condition for this to happen is the relative signal polarity of the HI outputmust be inverted with respect to the LOW outputs. If only SK filter sections were used, this requires that the connections to one speaker be reversed on installation. A lternately, with one inverting stage used in the LO channel, this accomplishes the same effect. In the circuit as shown, stage U1B is the MFB LP filter which provides the necessary polarity inversion. Like the SK sections, it is configured for unity gain and an  $\alpha$  of 2. The cutoff frequency is 500 Hz, which complements the SK HP section of U4.

In the filter sections, component values have been selected for good balance between reasonable physical/electrical size, and lowest noise and distortion. D C offset errors can be minimized by using dc compensation in the feedback and bias paths, ac bypassed with capacitors for low noise. Also, since the network input is reactive, it should driven from a directly coupled low impedance source at  $V_{\,\mathrm{I\!N}}$ .

Figure 40 shows this filter architecture adapted for single supply operation from a  $5\,\mathrm{V}$  dc source, along the lines discussed previously.

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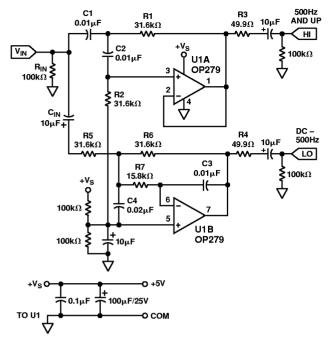


Figure 40. A Single-Supply, 2-Way Active Crossover

The crossover exam ple frequency of 500~H~z can be shifted lower or higher by frequency scaling of either resistors or capacitors. In configuring the circuit for other frequencies, complementary LP/HP action must be maintained between sections, and component values within the sections must be in the same ratio. Table II provides a design aid to adaptation, with suggested standard component values for other frequencies.

Table II. RC Component Selection for Various Crossover Frequencies

Crossover Frequency (Hz)	R1/C1 (U1A)* R5/C3 (U1B)**
100	160 kΩ/0.01 μF
200	80.6 kΩ/0.01 μF
319	49.9 kΩ/0.01 μF
500	31.6 kΩ/0.01 μF
1 k	16 kΩ/0.01 μF
2 k	8.06 kΩ/0.01 μF
5 k	3.16 kΩ/0.01 μF
10 k	1.6 kΩ/0.01 μF

Table notes (applicable for  $\alpha = 2$ ).

#### References on Active Filters and Active Crossover Networks

- Sallen, R.P.; K.ey, E. L., "A Practical Method of Designing RC Active Filters," IRE Transactions on Circuit Theory, vol. CT-2, March 1955.
- 2. Huelsman, L.P.; Allen, P.E., Introduction to the Theory and Design of Active Filters, M. cG. raw—Hill, 1980.
- 3. Zum bahlen, H., "C hapter 6: Passive and Active Analog Filtering," within 1992 *Analog Devices Amplifier Applications Guide*.
- 4. Zum bahlen, H., "Speaker Crossovers," within Chapter 8 of 1993 Analog Devices System Applications Guide
- 5. Linkwitz, S., "Active Crossover Networks for Noncoincident Drivers," *JAES*, Vol. 24, #1, Jan #Feb 1976.

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<sup>\*</sup> For SK stage U 1A: R1 = R2, and C1 = C2, etc.

<sup>\*\*</sup> ForM FB stage U1B:R6 = R5,R7 = R5/2, and C4 = 2C3.

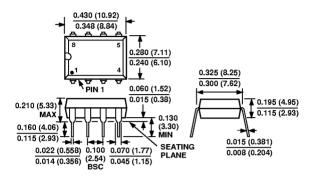
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D 2	2	4	DΧ			*OUTPUT STAGE						
R1	1	7	1.628E3				*					
R2 R3	1 5	8 99	1.628E 2.487E				RS1	99	39	6.0345E3		
R4	6	99	2.487E				RS2 RO1	39 99	50 45	6.0345E3 40		
C 1	5	6	5.333E	-12			RO2	99 45	50	40		
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C 2	9	98	20E-12	3			V 6	42	40	1.54		
V 1	99	10	0 .58				MOD		DΧ	D ()		
V2 D5	11 9	50 10	0.47				$M \circ D$	$\operatorname{EL}$	DΖ	D $(IS = 1E - 6)$		
D 6	9 11	9	D X D X				MOD		Q N I	1PN (BF=300)		
*		<i>y</i>	<i>D</i> 23				ΕΝD	S				
* C O M *	M O N -1	MODE	STAGE	WIT	Н :	ZERO AT 10 kH z						
ECM	15	98		(2) (3	,39	(2,39) 0 0 .5 0 .5						
R 9	15	16	1E 6									

REV. D -15-

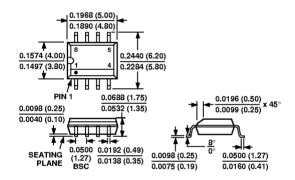
#### **OUTLINE DIMENSIONS**

D im ensions shown in inches and (mm).

#### 8- Lead Plastic DIP (N-8)



# 8- Lead Narrow-Body SO (SO-8)



#### 8-Lead TSSOP (RU-8)

